505181248 11/08/2018

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:			NEW ASSIGNMENT			
NATURE OF CONVEYANCE:			ASSIGNMENT			
CONVEYING PARTY	DATA					
			Name	Execution Date		
XINGCUN LI					11/06/2018	
RECEIVING PARTY D	ΑΤΑ					
Name:	BEIJIN	BEIJING NAURA MICROELECTRONICS EQUIPMENT CO., LTD.				
Street Address:		NO. 8 WENCHANG AVENUE BEIJING ECONOMIC-TECHNOLOGICAL DEVELOPMENT AREA				
City:	BEIJIN	BEIJING				
State/Country:	CHINA	CHINA				
PROPERTY NUMBER	R Total: 1					
Property Type			Number	1		
Application Number:		16183964				
CORRESPONDENCE						
Fax Number:		• /	935-1394 e-mail address first; if that is un	<u></u>	oful it will be cont	
			nat is unsuccessful, it will be se			
		70343	4305759			
			spto@anovalaw.com			
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ATTORNEY DOCKET NUMBER:			00191.0019.00US			
NAME OF SUBMITTER:			WENDY LIN			
SIGNATURE:			/Wendy Lin/			
DATE SIGNED:		11/08/2018				
Total Attachments: 2						
source=AssignDecl001 source=AssignDecl001	-	-				

Anova Ref: 00191.0019.00US

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ASSIGNMENT AND DECLARATION

WHEREAS I/We, the below named inventor(s) (hereinafter referred to as Assignor(s)) have made an invention entitled:

REACTION CHAMBER AND SEMICONDUCTOR PROCESSING APPARATUS

for which I/We executed an application for United States Letters Patent concurrently herewith or filed an application for United States Letters Patent on _______(Application No. ______); and

WHEREAS, <u>BELING NAURA MICROELECTRONICS EQUIPMENT CO., LTD.</u>, a corporation of <u>P.R.China</u>, whose post office address is <u>No.8 Wenchang Avenue</u>, <u>Beijing Economic-Technological</u> <u>Development Area. Beijing 100176, P.R. China</u> (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

AND, I/WE HEREBY covenant that I/We have the full right to convey the interest assigned by this Assignment, and I/We have not executed and will not execute any agreement in conflict with this Assignment;

AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to me/us respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys I/we have empowered in the Declaration and Power of Attorney in this application, to insert here in parentheses (Application No._________) filed _______) the filing date and application number of said application when known.

~1-

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Further, as a below named inventor, I hereby declare that:

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I have reviewed and understand the contents of the above-identified application, including the claims.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37,Code of Federal Regulations § 1.56, including for continuation-in-part applications, material information which became available between the filing data of the prior application and the national or PCT International filing date of the continuation-in-part application.

I hereby acknowledge that any willful faise statement made in this declaration is punishable under 18 U.S.C. §1001 by fine or imprisonment of not more than five (5) years, or both.

IN TESTIMONY WHEREOF, I/We have hereunto set our hands.

Inventor 1 Legal Name:

Xingcun Li

Signature:

Date: 1.4.

PATENT REEL: 047450 FRAME: 0461

RECORDED: 11/08/2018